

# **Technical Data Sheet**

# 1206 Package Infrared Chip LED With Inner Lens

#### Features

- Small double-end package
- High reliability
- Low forward voltage
- Good spectral matching to Si photodetector
- Package in 8mm tape on 7" diameter reel
- Pb free
- The product itself will remain within RoHS compliant version.

### Descriptions

IR11-21C/L302/TR8 is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with flat top view lens. The device is spectrally matched with silicon photodiode and phototransistor.

### Applications

- PCB mounted infrared sensor
- Infrared emitting for miniature light barrier
- Floppy disk drive
- Optoelectronic switch
- Smoke detector

### **Device Selection Guide**

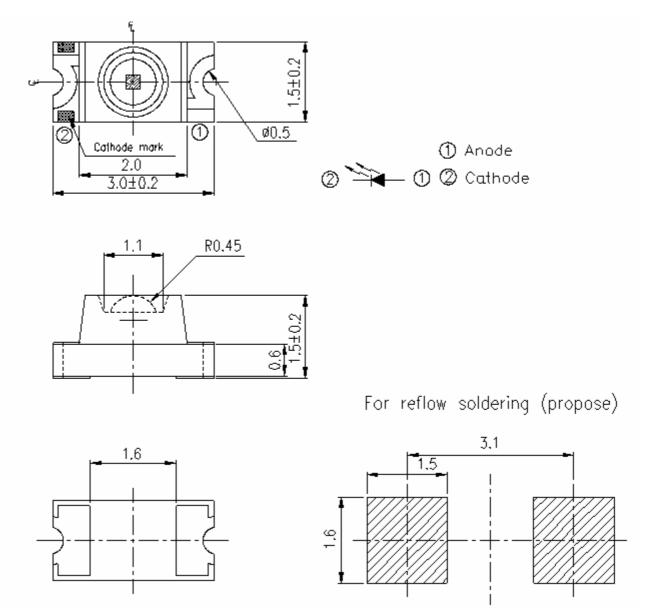
Part No.	Chip	Desin Color	
	Material	Resin Color	
IR	GaAlAs	Water Clear	



IR11-21C/L302/TR8



### **Package Dimensions**



#### **Notes:** 1.All dimensions are in millimeters 2.Tolerances unless dimensions ±0.1mm

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### Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Units	
Reverse Voltage	V <sub>R</sub>	5	V	
Continuous Forward Current	I <sub>F</sub>	65	mA	
Power Dissipation at(or below) 25℃ Free Air Temperature	P <sub>d</sub>	130	mW	
Operating Temperature	T <sub>opr</sub> -25 ~ +85		°C	
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	°C	
Soldering Temperature	Tsol	Reflow Soldering : 260 $^{\circ}$ C for 10 sec. Hand Soldering : 350 $^{\circ}$ C for 3 sec.		

### **Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Radiant Intensity	Ie	1.25	2.25		mW/sr		
Viewing Angle	2 <del>0</del> 1/2		100		deg		
Peak Wavelength	λp		940		nm	I <sub>F</sub> =20mA	
Spectrum Radiation Bandwidth	$ riangle \lambda$		45		nm		
Forward Voltage	$V_{\rm F}$		1.2	1.5	V		
Reverse Current	I <sub>R</sub>			10	μA	V <sub>R</sub> =5V	

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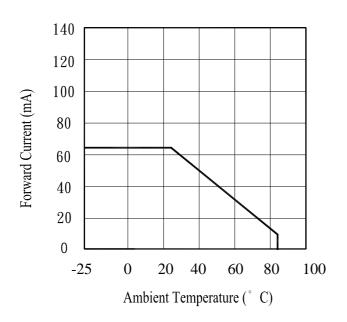


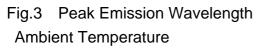
### **Typical Electro-Optical Characteristics Curves**

Fig.1 Forward Current vs.

Fig.2 Spectral Distribution

Ambient Temperature





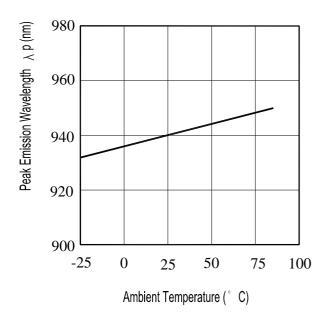
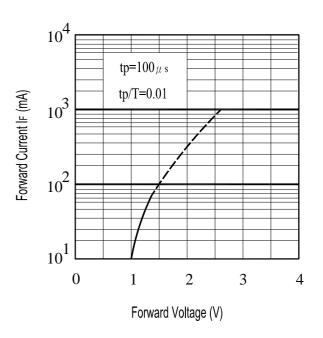
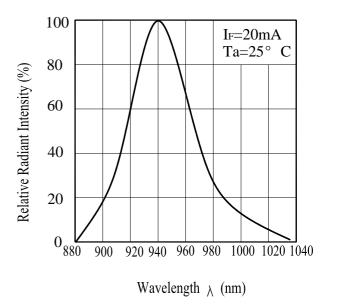


Fig.4 Forward Current vs. Forward Voltage



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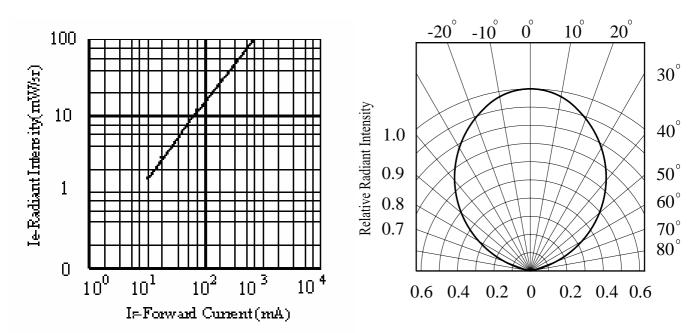


### **Typical Electro-Optical Characteristics Curves**

Fig.5 Relative Intensity vs.

Forward Current

Fig.6 Relative Radiant Intensity vs. Angular Displacement



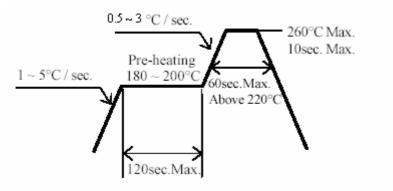


### **Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change ( Burn out will happen ).

- 2. Storage
  - 2.1 Do not open moisture proof bag before the products are ready to use.
  - 2.2 Before opening the package, the LEDs should be kept at  $30^{\circ}$ C or less and 90%RH or less.
  - 2.3 After opening the package: The LED's floor life is 1 year under 30℃ or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
  - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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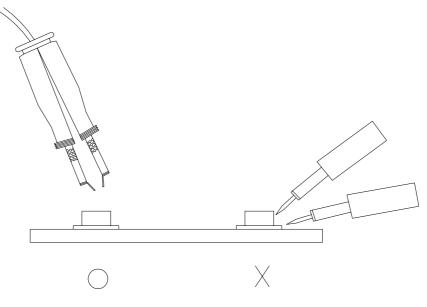


4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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#### **Reliability Test Item And Condition**

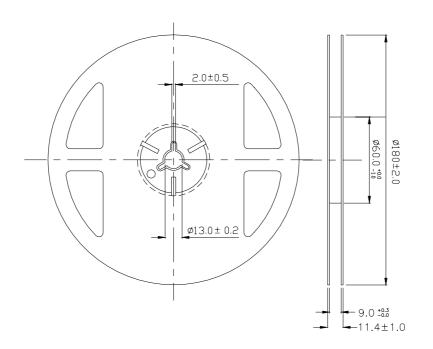
The reliability of products shall be satisfied with items listed below. Confidence level : 90%

LTPD: 10%

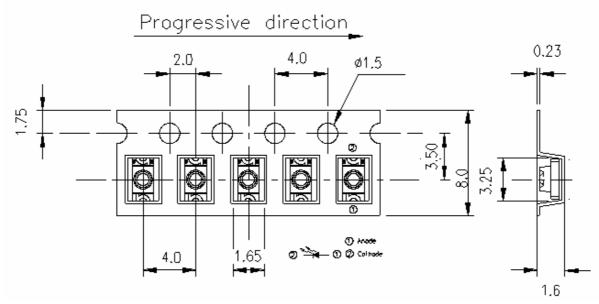
NO.	Item	Test Conditions	Test Hours/	Sample	Failure	Ac/Re
			Cycles	Sizes	Judgement	
					Criteria	
1	REFLOW Soldering	TEMP. $: 260^{\circ}C \pm 5^{\circ}C$	6Mins	22pcs		0/1
		10secs			$I_R \ge U \times 2$	
2	Temperature Cycle	$H:+100^{\circ}C$ 15mins	50Cycles	22pcs	$Ie \leq Lx0.8$	0/1
		5mins			$V_F \ge U x 1.2$	
		$L:-40^{\circ}C$ 15mins				
3	Thermal Shock	H :+100°C $\blacktriangle$ 5mins	50Cycles	22pcs	U : Upper	0/1
		▼ 10secs	-		Specification	
		$L:-10^{\circ}C$ 5mins			Limit	
4	High Temperature	TEMP. ∶ +100°C	1000hrs	22pcs	L: Lower	0/1
	Storage				Specification	
5	Low Temperature	<b>TEMP.</b> ∶ -40°C	1000hrs	22pcs	Limit	0/1
	Storage					
6	DC Operating Life	I <sub>F</sub> =20mA	1000hrs	22pcs		0/1
7	High Temperature/	85°C / 85% R.H	1000hrs	22pcs		0/1
	High Humidity					



#### **Package Dimensions**



#### **Taping Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$  mm, Unit = mm

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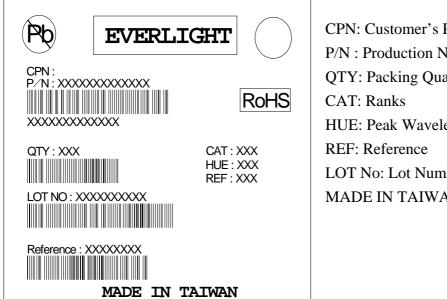


### **Packing Quantity Specification**

1.2000PCS/1Bag , 20Bags/1Box

2.10Boxes/1Carton

### Label Form Specification



CPN: Customer's Production Number P/N : Production Number QTY: Packing Quantity CAT: Ranks HUE: Peak Wavelength REF: Reference LOT No: Lot Number MADE IN TAIWAN: Production Place

### Notes

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- 3. These specification sheets include materials protected under copyright of EVERLIGHT corporation. Please don't reproduce or cause anyone to reproduce them without EVERLIGHT's consent.

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